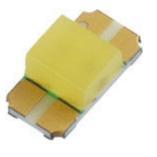
# **VLMW1300**



**Vishay Semiconductors** 

# Highbright 0603 ChipLED



#### DESCRIPTION

The new 0603 ChipLED series have been designed in the smallest SMD package. This innovative 0603 ChipLED technology opens the way to

- smaller products of higher performance
- · more design in flexibility
- enhanced applications

The 0603 LED is an obvious solution for small-scale products that are expected to work reliably in an arduous environment.

This package is filled with a mixture of epoxy and yellow converter.

This yellow converter converts the blue emission partially to yellow, which mixes the remaining blue to give white.

#### **PRODUCT GROUP AND PACKAGE DATA**

- Product group: LED
- Package: SMD 0603 ChipLED
- · Product series: standard
- Angle of half intensity: ± 65°

#### **FEATURES**

- High efficient InGaN technology
- Super thin ChipLED with exceptional brightness 1.6 mm x 0.8 mm x 0.55 mm (L x W x H)
- High reliability PCB based
- Temperature range 20 °C to + 80 °C
- Chromaticity coordinate categorized according to CIE 1931 per packing unit
- Typical color temperature 7000 K
- EIA standard package
- Compatible to IR reflow soldering
- · Available on 7" diameter reel
- Preconditioning: according to JEDEC level 2a
- · Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- ESD-sensitive device

#### Note

Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

#### APPLICATIONS

- Telecommunication: indicator and backlighting in telephone and fax
- · Backlighting for audio and video equipment
- Backlighting in office equipment
- · Indoor and outdoor message boards
- Flat backlight for LCDs, switches and symbols

PARTS TABLE												
PART	COLOR	LUMIN	UMINOUS INTENSITY (mcd)		at I <sub>F</sub> - (mA)	WAVELENGTH (nm)		FORWARD VOLTAGE (V)		TECHNOLOGY		
		MIN. TYP.	MAX.	MIN.		TYP.	MAX.	MIN.	TYP.	MAX.		
VLMW1300-GS08	White	45	-	180	5	-	-	-	2.70	-	3.15	InGaN/ yellow converter

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified) VLMW1300						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
DC forward current	T <sub>amb</sub> ≤ 25 °C	I <sub>F</sub>	20	mA		
Surge forward current	t <sub>p</sub> ≤ 10 μs	I <sub>FSM</sub>	0.1	А		
Power dissipation		Pv	70	mW		
Operating temperature range		T <sub>amb</sub>	- 20 to + 80	°C		
Storage temperature range		T <sub>stg</sub>	- 55 to + 105	°C		
Thermal resistance junction/ambient		R <sub>thJA</sub>	550	K/W		

Rev. 1.0, 08-Nov-11



RoHS

COMPLIANT

(5-2008)\*\*

**GREEN** 

## **VLMW1300**



## **Vishay Semiconductors**

<b>OPTICAL AND ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25 \text{ °C}$ , unless otherwise specified) <b>VLMW1300, WHITE</b>						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	I <sub>F</sub> = 5 mA	Ι <sub>V</sub>	45	-	180	mcd
Chromatically coordinate x acc. to CIE 1931	I <sub>F</sub> = 5 mA	х	-	0.294	-	
Chromatically coordinate y acc. to CIE 1931	I <sub>F</sub> = 5 mA	У	-	0.286	-	
Angle of half intensity	I <sub>F</sub> = 5 mA	φ	-	± 65	-	deg
Forward voltage	I <sub>F</sub> = 5 mA	V <sub>F</sub>	2.70	-	3.15	V
Reverse current <sup>(1)</sup>	$V_R = 5 V$	I <sub>R</sub>	-	10	-	μA

#### Note

<sup>(1)</sup> Driving the LED in reverse direction is suitable for short term application

LUMINOUS INTENSITY CLASSIFICATION					
GROUP	LUMINOUS INTENSITY (mcd) at 5 mA				
	MIN.	MAX.			
Р	45	71			
Q	71	112			
R	112	180			

#### Note

 Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 15 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

GROUP	FORWARD VOLTAGE (V)				
GNOUP	MIN.	MAX.			
А	2.7	2.85			
В	2.85	3.0			
С	3.0	3.13			

Note

• Forward voltage is measured with a tolerance of ± 0.1 V.

CHROMATICI	CHROMATICITY COORDINATED GROUPS FOR WHITE SMD LED							
	X	Y		X	Y			
	0.274	0.226		0.294	0.286			
S1	0.274	0.258	S4	0.294	0.319			
51	0.294	0.286	- 34	0.314	0.347			
	0.294	0.254		0.314	0.315			
	0.274	0.258		0.314	0.282			
S2	0.274	0.291	S5	0.314	0.315			
52	0.294	0.319	55	0.334	0.343			
	0.294	0.286		0.334	0.311			
	0.294	0.254		0.314	0.315			
S3	0.294	0.286	S6	0.314	0.347			
	0.314	0.315	50	0.334	0.376			
	0.314	0.282		0.334	0.343			

#### Note

• Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of ± 0.01.

For technical questions, contact: <u>LED@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



**Vishay Semiconductors** 

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

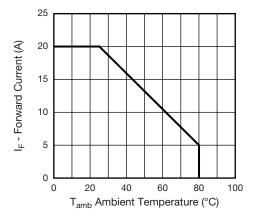


Fig. 1 - Forward Current vs. Ambient Temperature

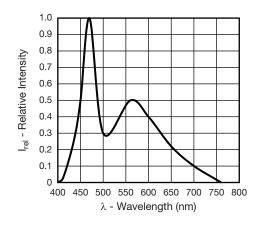


Fig. 2 - Relative Intensity vs. Wavelength

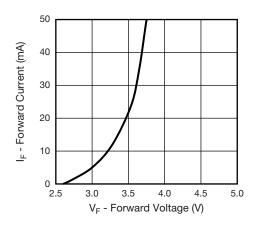


Fig. 3 - Forward Current vs. Forward Voltage

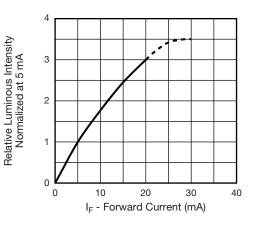


Fig. 4 - Relative Luminous Intensity vs. Forward Current

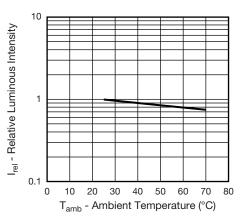


Fig. 5 - Rel. Luminous Intensity vs. Ambient Temperature

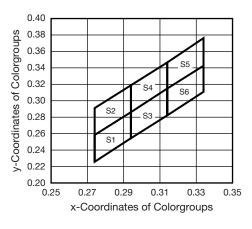


Fig. 6 - Coordinates of Colorgroups

Document Number: 82435

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





## Vishay Semiconductors

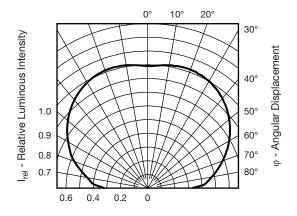
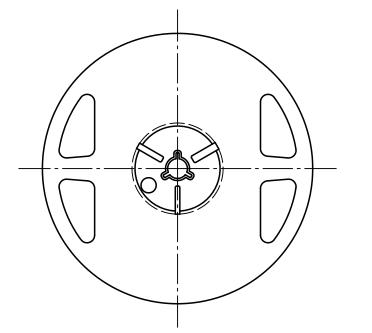
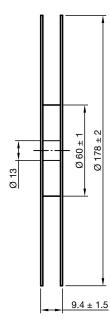
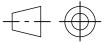


Fig. 7 - Relative Luminous Intensity vs. Angular Displacement

#### **REEL DIMENSIONS** in millimeters







technical drawings according to DIN specifications

Drawing-No.: 9.800-5122.01-4 Issue: 2; 03.11.11 22611

4
For technical questions, contact: LED@vishay.com

Document Number: 82435

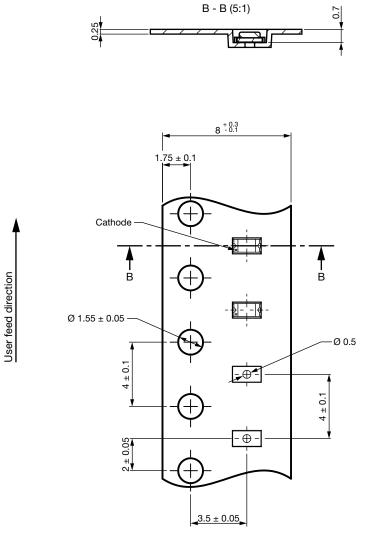
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





Vishay Semiconductors

#### TAPE DIMENSIONS in millimeters





technical drawings according to DIN specifications

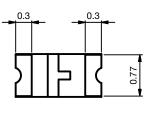
Drawing-No.: 9.700-5385.01-4 Issue: 1; 17.10.11 22612

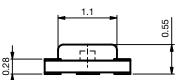
For technical questions, contact: <u>LED@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



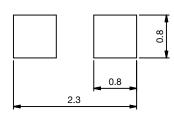
# www.vishay.com

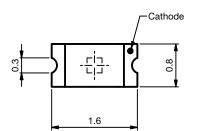
#### **PACKAGE DIMENSIONS** in millimeters





Recommended solder pad footprint







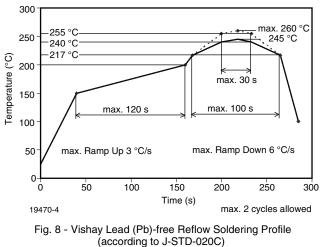


technical drawings according to DIN specifications

Not indicated tolerances  $\pm 0.2$ 

Drawing-No.: 6.541-5091.01-4 Issue: 1; 17.10.11 22613

### SOLDERING PROFILE



IR Reflow Soldering Profile for lead (Pb)-free Soldering Preconditioning acc. to JEDEC Level 2

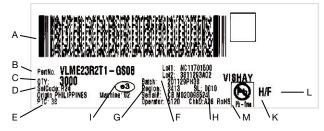
Rev. 1.0, 08-Nov-11

6 For technical questions, contact: <u>LED@vishay.com</u>

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



#### BAR CODE PRODUCT LABEL (example)

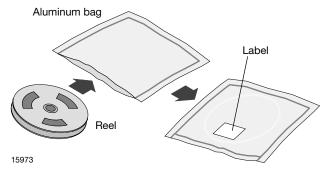


A) 2D barcode

- B) PartNo = Vishay part number
- C) QTY = quantity
- D) SelCode = selection code (binning)
- E) PTC = code of manufacturing plant
- F) Batch = date code: year/week/plant code
- G) Region code
- H) SL = sales location
- I) Terminations finishing
- J) Lead (Pb)-free symbol
- K) Halogen-free symbol
- L) RoHS symbol

#### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## **Vishay Semiconductors**

#### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity  $\leq 60$  % RH max.

or

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40  $^{\circ}C$  + 5  $^{\circ}C/-0$   $^{\circ}C$  and < 5  $^{\circ}N$  RH (dry air/nitrogen)

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC Standard JESD22-A112 Level 2a label is included on all dry bags.

CAUTION This bag contains MOISTURE -SENSITIVE DEVICES
1. Shelf life in sealed bag 12 months at <40°C and < 90% relative humidity (RH)
<ul> <li>2. After this bag is opened devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 260°C) must be:</li> <li>a) Mounted within 672 hours at factory condition of ≤ 30°C/60%RH or</li> <li>b) Stored at ≤10% RH.</li> </ul>
<ul> <li>3. Devices require baking before mounting if:</li> <li>a) Humidity Indicator Card is &gt;10% when read at 23°C ± 5°C or</li> <li>b) 2a or 2b is not met.</li> </ul>
4. If baking is required, devices may be baked for:         192 hours at 40°C + 5°C/-0°C and <5%RH (dry air/nitrogen)
Bag Seal Date:
Note: LEVEL defined by EIA JEDEC Standard JESD22-A113

Example of JESD22-A112 Level 2a Label

### ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

#### VISHAY SEMICONDUCTORS STANDARD **BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



Vishay

# Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.